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恒安國際集團有限公司*

HENGAN INTERNATIONAL GROUP COMPANY LIMITED

(Incorporated in the Cayman Islands with limited liability)

(Stock code: 1044)

Websites: <http://www.hengan.com>

<http://www.irasia.com/listco/hk/hengan>

ANNOUNCEMENT

APPLICATION TO THE SHANGHAI STOCK EXCHANGE FOR REGISTRATION AND PROPOSED ISSUE OF DOMESTIC CORPORATE BONDS IN THE PRC

This announcement is made by Hengan International Group Company Limited (the “**Company**”, together with its subsidiaries, the “**Group**”) pursuant to Rule 13.09(2) of the Rules Governing the Listing of Securities on The Stock Exchange of Hong Kong Limited (the “**Listing Rules**”) and the Inside Information Provisions (as defined in the Listing Rules) under Part XIVA of the Securities and Futures Ordinance (Chapter 571 of the Laws of Hong Kong).

The board of directors of the Company hereby announces that the Company has made an application to the Shanghai Stock Exchange (the “**SSE**”) for registration of domestic corporate bonds in the People’s Republic of China (the “**PRC**”) in an aggregate amount of not more than RMB5.0 billion (the “**Domestic Bonds**”) to be issued in multiple tranches as and when appropriate (the “**Proposed Issue**”). Each tranche of the Domestic Bonds shall have a term of not more than five years. The application is still in progress, and the Company will make further announcement(s) as and when appropriate.

If the Proposed Issue proceeds, the proceeds raised from the Domestic Bonds are intended to be used for supplementing the working capital requirements of the Group, and repayment of the domestic bonds of the Company in the PRC. In case of any inconsistency, the information set out in the offering circular published at the time of issuance of the Domestic Bonds shall prevail.

* *For identification purposes only*

Drafts of documents relating to the application, including certain financial information of the Company, have been made available on the website of the SSE at www.sse.com.cn. As the application and the Proposed Issue may or may not proceed, the above information disclosed on the website of the SSE may be subject to changes. Therefore, shareholders and potential investors of the Company are advised to exercise caution when dealing in the securities of the Company.

By order of the Board
Hengan International Group Company Limited
Sze Man Bok
Chairman

Hong Kong, 19 June 2020

As at the date of this announcement, the Board comprises Mr. Sze Man Bok, Mr. Hui Lin Chit, Mr. Hung Ching Shan, Mr. Xu Shui Shen, Mr. Xu Da Zuo, Mr. Xu Chun Man, Mr. Sze Wong Kim, Mr. Hui Ching Chi and Mr. Li Wai Leung as executive directors, and Mr. Chan Henry, Mr. Theil Paul Marin, Ms. Ada Ying Kay Wong, Mr. Ho Kwai Ching, Mark and Mr. Zhou Fang Sheng as independent non-executive directors.